

IDC Header

Lugged 16 Way



Specifications:

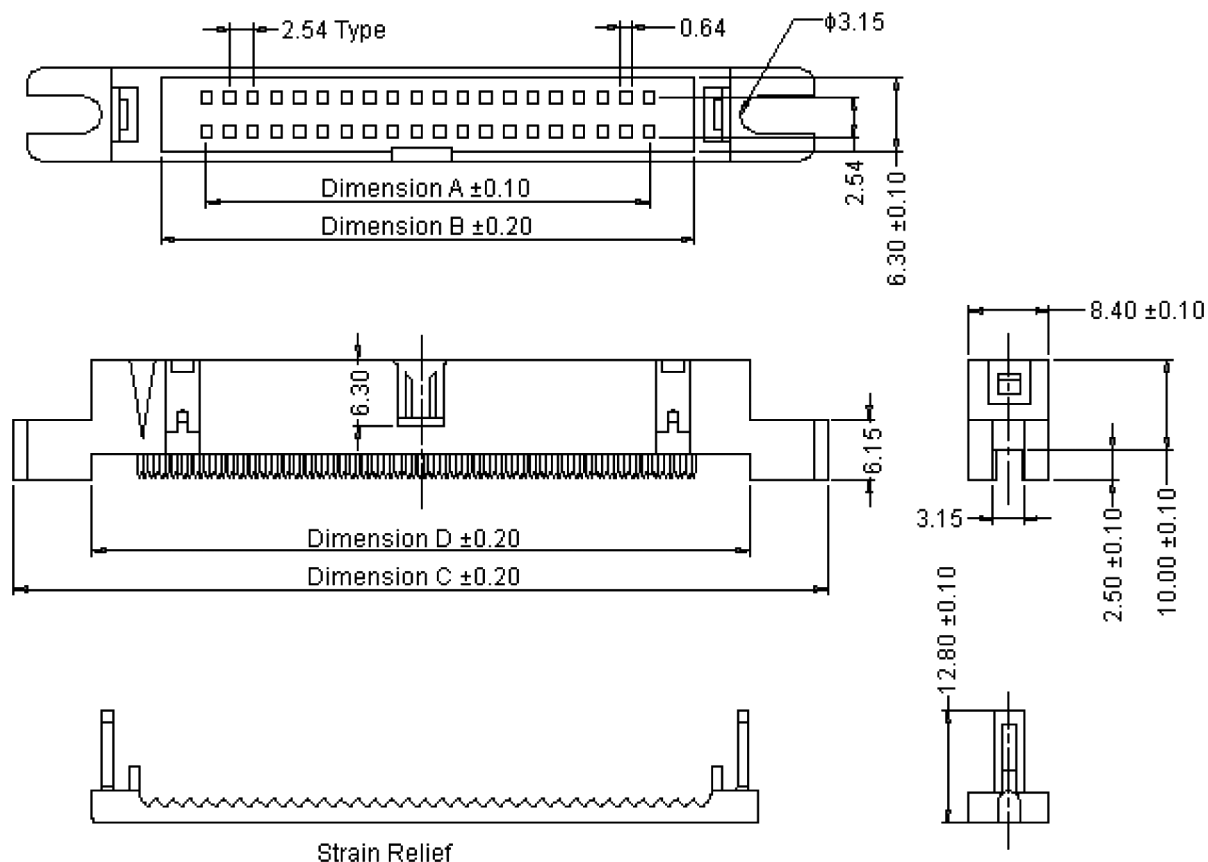
Current Rating	: 1A AC/DC
Voltage Rating	: 30V AC/DC
Maximum Contact Resistance	: 20mΩ
Minimum Insulation Resistance	: 1,000MΩ
Withstanding Voltage	: 500V AC for one minute
Operating Temperature Range Max	: -40°C to +105°C
Connector Type	: Wire to Board
Contact Termination	: IDC / IDT
Gender	: Plug
No. of Contacts	: 16
No. of Rows	: 2
Pitch Spacing	: 2.54mm

Material and Finish:

Insulator	: High temperature plastic
Contact	: Copper alloy
Contact Plating	: Selective Gold Plating

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Dimensions : Millimetres

Engineering Dimension

Circuits	Dimension A	Dimension B	Dimension C	Dimension D
16	17.78	25.62	44.82	30.62

Dimensions : Millimetres

Part Number Table

Description	Part Number
Header, IDC Lugged, 16Way	4406-16SR

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